



The ZMS030N06F combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{DS(ON)}$.

device constructure
 $R_{DS(ON)}$ to minimize conduction loss

$T_C = 25$

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DS}	60	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current	$I_{D@TC=25}$	85	A
	$I_{D@TC=75}$	65	A
	$I_{D@TC=100}$	54	A
Pulsed Drain Current	I_{DM}	200	A
Total Power Dissipation($TC=25$)	$P_D@TC=25$	85	W
Total Power Dissipation($TA=25$)	$P_D@TA=25$	3	W
Operating Junction Temperature	T_J	-55 to 150	
Storage Temperature	T_{STG}	-55 to 150	
Single Pulse Avalanche Energy@ $L=0.1mH$	E_{AS}	245	mJ
Avalanche Current@ $L=0.1mH$	I_{AS}	70	A



Fig.1 Gate-Charge Characteristics

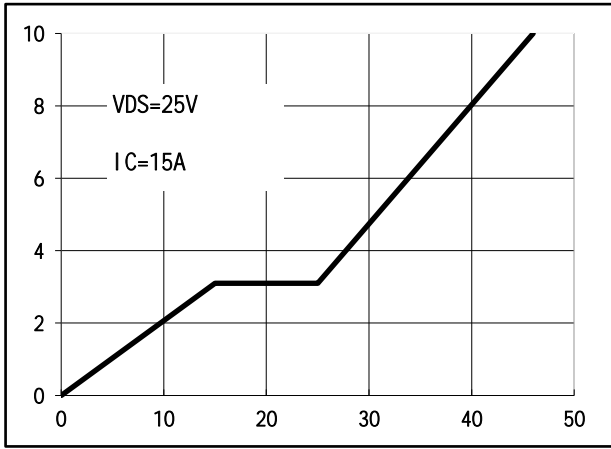


Fig.2 Capacitance Characteristics

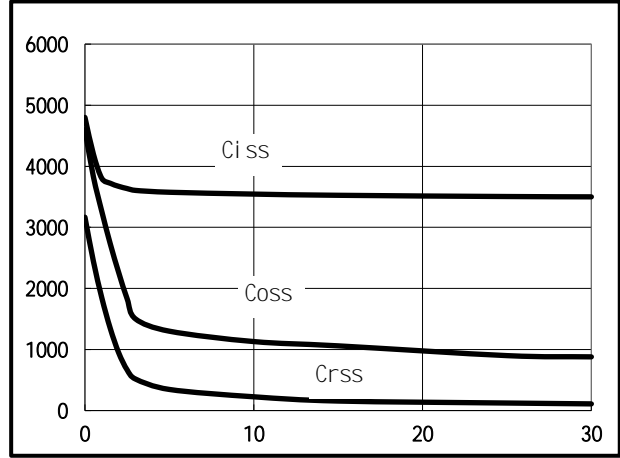


Fig.3 Power Dissipation

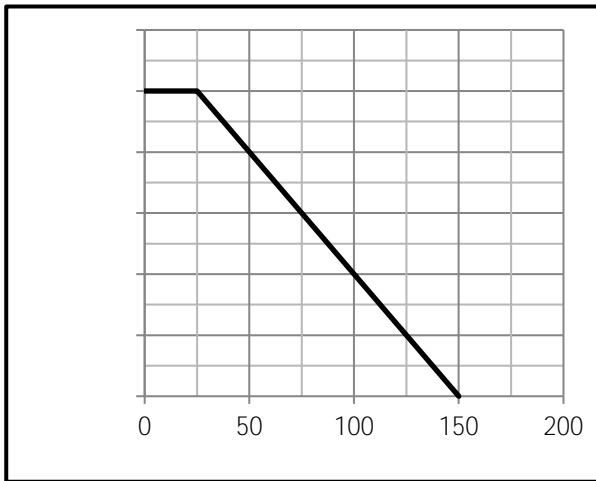


Fig.4 Typical output Characteristics

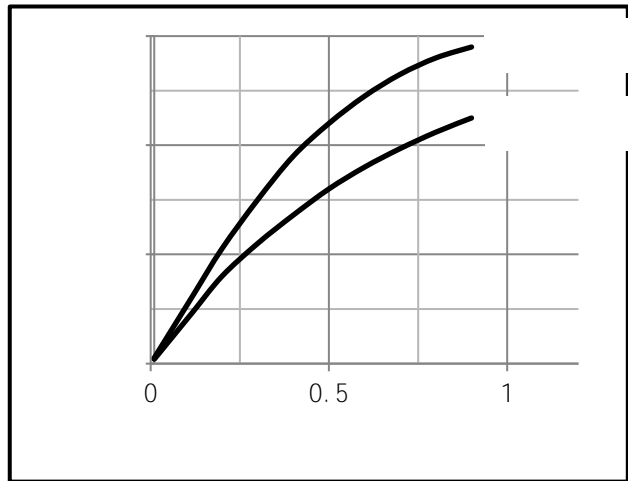


Fig.5 Threshold Voltage V.S Junction Temperature

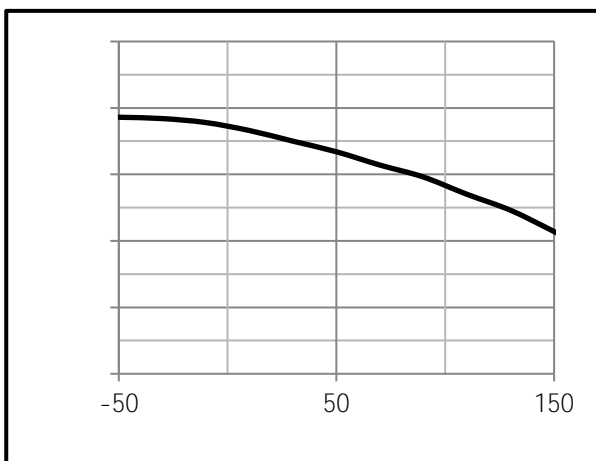
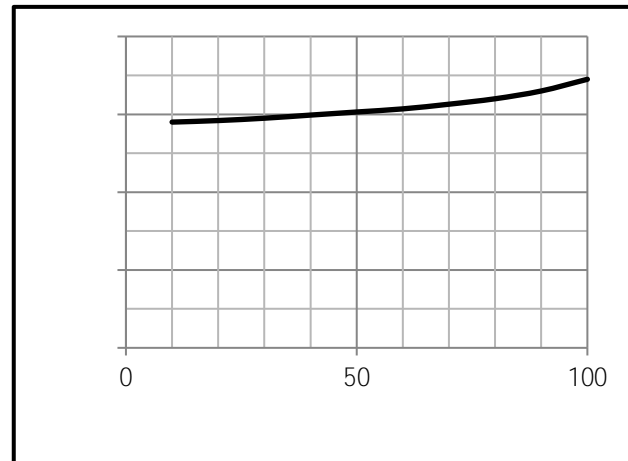
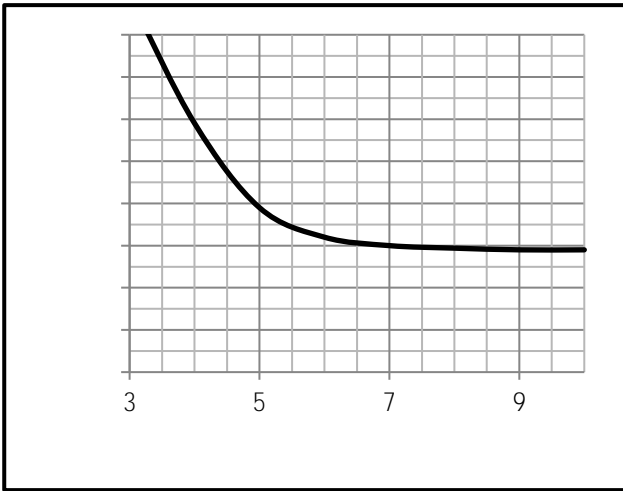


Fig.6 Resistance V.S Drain Current





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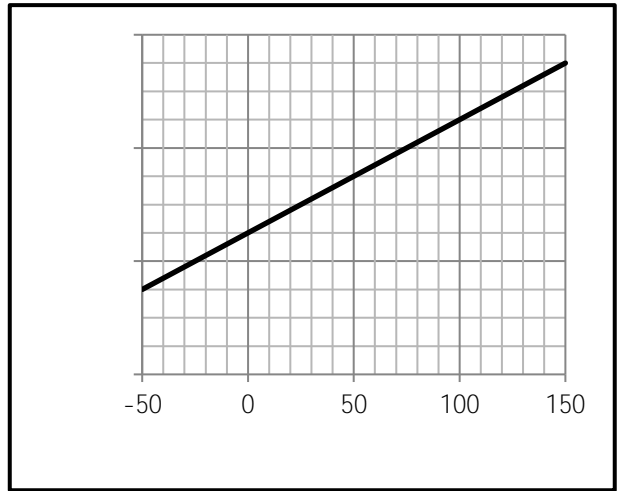


Fig.9 Switching Time Measurement Circuit

Fig.10 Gate Charge Waveform

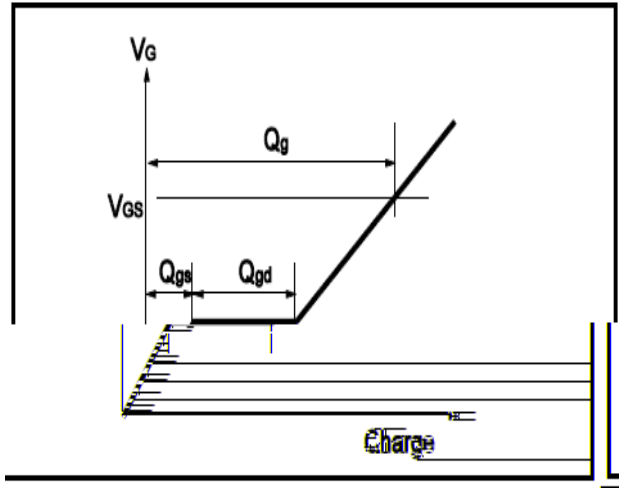
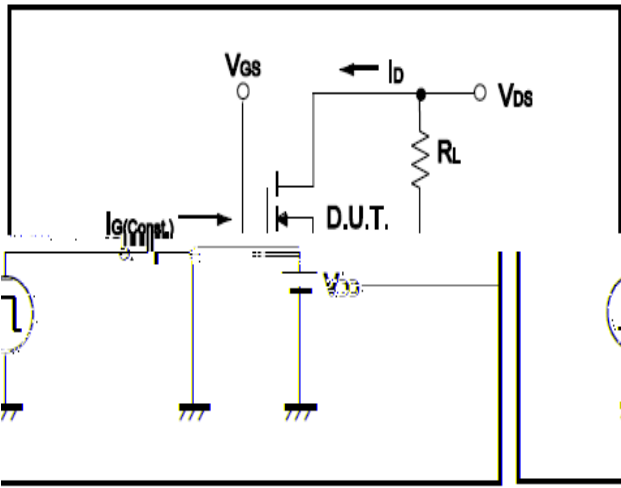
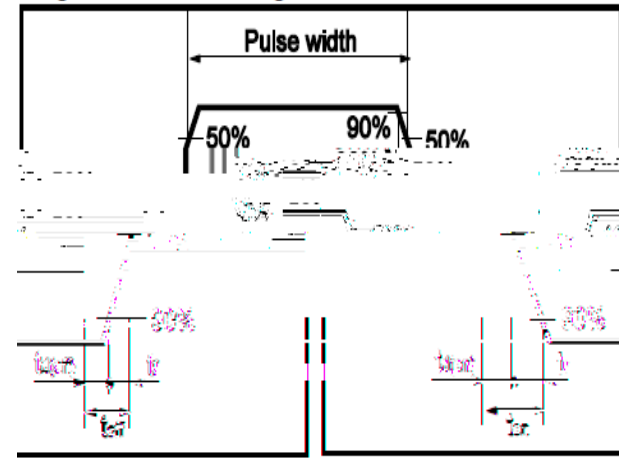
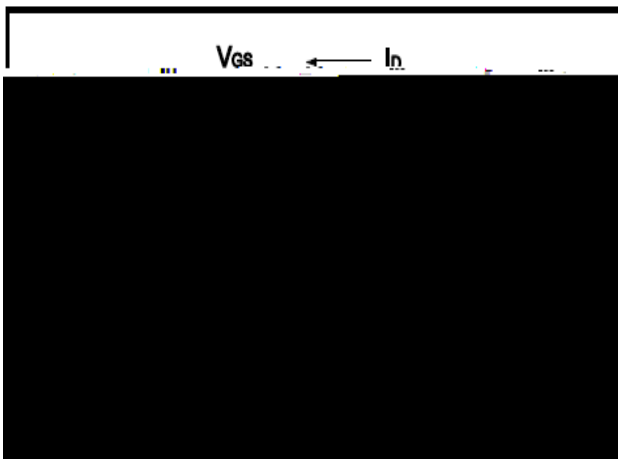


Fig.11 Switching Time Measurement Circuit

Fig.12 Gate Charge Waveform





Dimensions (TO-220F)

Unit mm

